

5000W, 16V - 100V Surface Mount Transient Voltage Suppressor

FEATURES

- AEC-Q101 qualified
- 5000W peak pulse power capability at 10/1000µs waveform
- Ideal for automated placement
- Photo glass passivated junction
- Excellent clamping capability
- Fast response time: Typically less than 1.0ps
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- I/O interface
- AC/DC power supply

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.300g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
V_{WM}	16 - 100	V		
V _{BR} (uni-directional)	17.8 - 123	٧		
P _{PPSM}	5000	W		
T _{J MAX}	175	°C		
Package	DO-214AB (SMC)			
Configuration	Stacked die			









DO-214AB (SMC)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Non-repetitive peak impulse power dissipation with 10/1000us waveform ⁽¹⁾	P _{PK}	5000	W		
Steady state power dissipation at T _L = 75°C ⁽²⁾	P_D	6.25	W		
Forward Voltage @ I _F = 100A for Uni-directional only ⁽³⁾	V _F	5	V		
Junction temperature	T _J	-55 to +175	°C		
Storage temperature	T _{STG}	-55 to +175	°C		

Notes

- 1. Non-repetitive current pulse per Fig.3 and derated above $T_A = 25$ °C Per Fig.1
- 2. Units mounted on PCB (16mm x 16mm Cu pad test board)
- 3. Pulse test with PW = 0.3ms

THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	R _{eJL}	16	°C/W		
Junction-to-ambient thermal resistance	R _{eJA}	61	°C/W		
Junction-to-case thermal resistance	R _{eJC}	17	°C/W		

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)



ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)									
Part number	Marking code	Break volta V _{BR} ((Not	age @I _T /)	Test current I _T (mA)	voltage V _{WM}	Maximum blocking leakage current l _{IB} @V _{WM} (μA)	Maximum peak impulse current	Maximum clamping voltage	$\begin{tabular}{ll} Maximum \\ Temp. \\ coefficient \\ of V_{BR} \\ $\alpha V_{BR}@I_T$ \\ \end{tabular}$
Uni	Uni	Min	Max		(V)	(Note 1)	(A)	(-)	(mV/°C)
5.0SMDJ16AH	5PET	17.8	19.7	1	16	50	193	26.0	0.096
5.0SMDJ17AH	5PEU	18.9	20.9	1	17	20	181	27.6	0.097
5.0SMDJ18AH	5PEV	20.0	22.1	1	18	10	172	29.2	0.098
5.0SMDJ20AH	5PEW	22.2	24.5	1	20	5	155	32.4	0.099
5.0SMDJ22AH	5PEX	24.4	26.9	1	22	5	141	35.5	0.100
5.0SMDJ24AH	5PEZ	26.7	29.5	1	24	2	129	38.9	0.101
5.0SMDJ26AH	5PFE	28.9	31.9	1	26	2	119	42.1	0.101
5.0SMDJ28AH	5PFG	31.1	34.4	1	28	2	110	45.4	0.102
5.0SMDJ30AH	5PFK	33.3	36.8	1	30	2	103	48.4	0.103
5.0SMDJ33AH	5PFM	36.7	40.6	1	33	2	93.9	53.3	0.104
5.0SMDJ36AH	5PFP	40.0	44.2	1	36	2	86.1	58.1	0.104
5.0SMDJ40AH	5PFR	44.4	49.1	1	40	2	77.6	64.5	0.105
5.0SMDJ43AH	5PFT	47.8	52.8	1	43	2	72.1	69.4	0.105
5.0SMDJ45AH	5PFV	50.0	55.3	1	45	2	68.8	72.7	0.106
5.0SMDJ48AH	5PFX	53.3	58.9	1	48	2	64.7	77.4	0.106
5.0SMDJ51AH	5PFZ	56.7	62.7	1	51	2	60.7	82.4	0.107
5.0SMDJ54AH	5PGE	60.0	66.3	1	54	2	57.5	87.1	0.107
5.0SMDJ58AH	5PGG	64.4	71.2	1	58	2	53.5	93.6	0.107
5.0SMDJ60AH	5PGK	66.7	73.7	1	60	2	51.7	96.8	0.108
5.0SMDJ64AH	5PGM	71.1	78.6	1	64	2	48.6	103	0.108
5.0SMDJ70AH	5PGP	77.8	86.0	1	70	2	44.3	113	0.108
5.0SMDJ75AH	5PGR	83.3	92.1	1	75	2	41.4	121	0.108
5.0SMDJ78AH	5PGT	86.7	95.8	1	78	2	39.7	126	0.108
5.0SMDJ85AH	5PGV	94.4	104	1	85	2	36.5	137	0.110
5.0SMDJ90AH	5PGX	100	111	1	90	2	34.3	146	0.110
5.0SMDJ100AH	5PGZ	111	123	1	100	2	30.9	162	0.110

Note:

1. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE ⁽¹⁾ PACKAGE PACKING					
5.0SMDJxH	DO-214AB (SMC)	3,000 / Tape & Reel			

Notes:

1. "x" defines voltage from 16V(5.0SMDJ16AH) to 100V(5.0SMDJ100AH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Pulse Power or Current vs. Initial Junction
Temperature

DEBATING IN DERCENTAGE (Pp.) OR COURENT (Pp.) OR COURT (Pp.) OR CO

Fig.2 Power Derating Curve

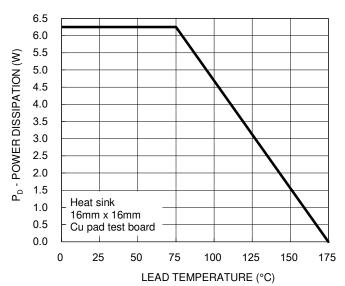


Fig.3 Pulse Waveform

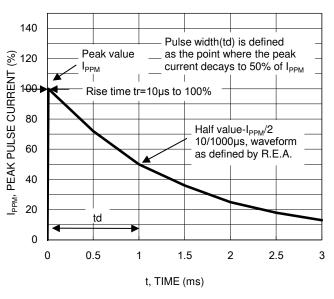
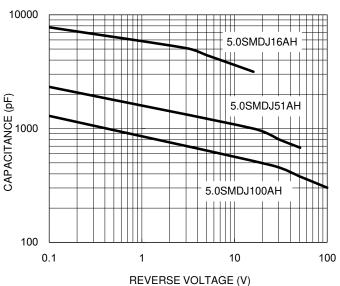
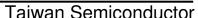


Fig.4 Typical Junction Capacitance

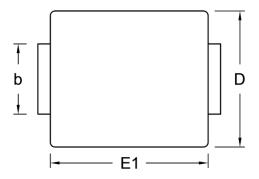


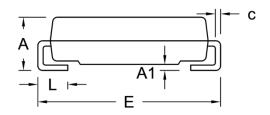




PACKAGE OUTLINE DIMENSIONS

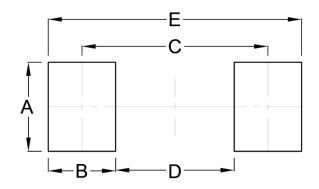
DO-214AB (SMC)





DIM.	Unit (mm)		Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	2.00	2.62	0.079	0.103	
A1	0.10	0.20	0.004	0.008	
b	2.90	3.20	0.114	0.126	
С	0.15	0.31	0.006	0.012	
D	5.59	6.22	0.220	0.245	
E	7.75	8.13	0.305	0.320	
E1	6.60	7.11	0.260	0.280	
L	1.00	1.60	0.039	0.063	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	3.30	0.130
В	2.50	0.098
С	6.90	0.272
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

ΥW = Date Code F = Factory Code



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